



# Product Change Notification

## 108729 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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# Product Change Notification

**Change Notification #:** 108729 - 00  
**Change Title:** DG33FB, PCN 108729-00, Product Design, BIOS update and component changes  
**Date of Publication:** August 21, 2008

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Sep 11, 2008
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## Description of Change to the Customer:

Update BIOS to DPP3510J.86A.0484

Please refer to the release notes posted at

<http://developer.intel.com/products/motherboard/DG33FB/tools.htm>

To enhance reliability the following component changes will be incorporated. A 10.0 uF capacitor will be added to location C8LN along with a 0.1 uF capacitor to location C20LN, a 4.7 uF capacitor to location C18LN, and a 2200 pF capacitor will be added to location M239BV. The resistors at locations R20TH and R27TH are being changed from 0.0 ohm to 200.0 ohm.

## Customer Impact of Change and Recommended Action:

This change has been thoroughly evaluated to ensure that there are no quality, reliability or functional implications to our customers. Intel is not recommending additional qualification of this change on platforms received from Intel.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change AA	Post Change AA
BOXDG33FBC	888156	D81072-308	D81072-309
BLKDG33FBC	888159	D81072-308	D81072-309

## PCN Revision History:

**Date of Revision:**

August 21, 2008

**Revision Number:**

00

**Reason:**

Originally Published PCN